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TLC59116F

SCLS714C - MARCH 2009 - REVISED SEPTEMBER 2015

TLC59116F 16-Channel Fast-Mode Plus I²C Bus LED Driver

1 Features

- 16 LED Drivers (Each Output Programmable at OFF, ON, LED Brightness, and Group Dimming/Blinking Mixed With Individual LED Brightness)
- 16 Open-Drain Output Channels
- 256-Step (8-Bit) Linear Programmable Brightness Per LED Output Varying From Fully OFF (Default) to Maximum Brightness Using a 97-kHz PWM Signal
- 256-Step Group Brightness Control Allows General Dimming (Using a 190-Hz PWM Signal From Fully OFF to Maximum Brightness (Default)
- 256-Step Group Blinking With Frequency Programmable From 24 Hz to 10.73 s and Duty Cycle from 0% to 99.6%
- Four Hardware Address Pins Allow 14 TLC59116F Devices to be Connected to the Same I²C Bus
- Four Software-Programmable I²C Bus Addresses (One LED Group Call Address and Three LED Sub-Call Addresses) Allow Groups of Devices to be Addressed Simultaneously in Any Combination (For example, One Register Used for 'All Call' So All the TLC59116Fs on the I²C Bus Can be Addressed at the Same Time and the Second Register Used for Three Different Addresses So That 1/3 of all Devices on the Bus Can Be Addressed at the Same Time in a Group). Software Enable and Disable for I²C Bus Address.
- Software Reset Feature (SWRST Call) Allows the Device to be Reset Through the I²C Bus
- Up to 14 Possible Hardware Adjustable Individual I²C Bus Addresses Per Device so That Each Device Can be Programmed
- Output State Change Programmable on the Acknowledge or the STOP Command to Update Outputs Byte-by-Byte or All at the Same Time (Default to *Change on STOP*).
- 120-mA Maximum Output Current
- 17-V Maximum Output Voltage
- 25-MHz Internal Oscillator Requires No External Components
- 1-MHz Fast-Mode Plus (FM+) Compatible I²C Bus Interface With 30 mA High Drive Capability on SDA Output for Driving High Capacity Buses
- Internal Power-On Reset
- Noise Filter on SCL/SDA Inputs
- No Glitch on Power Up

- Active-Low Reset
- Supports Hot Insertion
- Low Standby Current
- 3.3-V or 5-V Supply Voltage
- 5.5-V Tolerant Inputs
- 28-Pin TSSOP (PW)
- –40°C to 85°C Operation

2 Applications

- Gaming
- Small Signage
- Industrial Equipment

3 Description

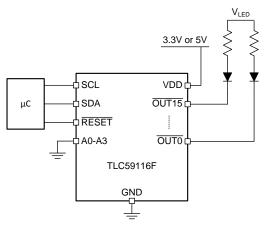
The TLC59116F is an I²C-bus controlled 16-channel LED driver optimized for red/green/blue/amber (RGBA) color mixing applications. Each LED output has its own 8-bit resolution (256 steps) fixed frequency individual PWM controller that operates at 97 kHz with a duty cycle that is adjustable from 0% to 99.6% to allow the LED to be set to a specific brightness value. An additional 8-bit resolution (256 steps) group PWM controller has both a fixed frequency of 190 Hz and an adjustable frequency between 24 Hz to once every 10.73 seconds with a duty cycle that is adjustable from 0% to 99.6% that is used to either dim or blink all LEDs with the same value.

Device	Information	(1)
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PART NUMBER	PACKAGE	BODY SIZE (NOM)
TLC59116F	TSSOP (28)	9.70 mm × 4.40 mm
	VQFN (32)	5.00 mm × 5.00 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Application Schematic



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes	from	Revision	В	(Julv	2011) to	Revision	С
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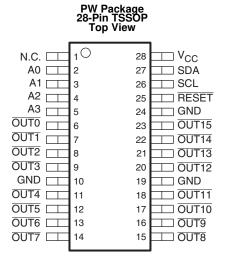
•	Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section	1
•	Removed Thermal Impedence table from Specifications	5
•	Added Figure 1 and Figure 2 to Typical Characteristics	6
•	Removed Figure 9 from <i>Control Register</i>	16
	Added Figure 22 and Figure 23 to Layout Examples	

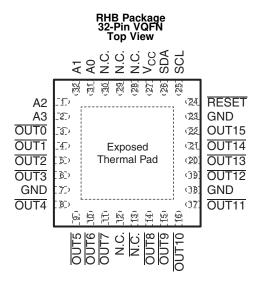
Changes from Revision A (June 2010) to Revision B

•	Changed QFN PIN NO. to fix	in assignment typo



5 Pin Configuration and Functions





If used, the exposed thermal pad must be connected as a secondary ground. N.C. – No internal connection

Pin Functions

PIN		I/O	DECODIDITION								
NAME	QFN (RHB)	TSSOP (PW)	1/0	DESCRIPTION							
A0	31	2	I	Address input 0							
A1	32	3	I	Address input 1							
A2	1	4	I	Address input 2							
A3	2	5	I	Address input 3							
GND	7, 18, 23	10, 19, 24	-	Power ground							
N.C.	12, 13, 28, 29, 30	1	-	No internal connection							
OUT0											
OUT1	3–6	6–9	0	Open-drain output 0 to 3, LED ON at low							
OUT2	5-0	0-9	0	Open-drain output 0 to 3, LED ON at low							
OUT3											
OUT4											
OUT5	Q 11	8–11 11–14	0	Open-drain output 4 to 7, LED ON at low							
OUT6	0-11										Ŭ
OUT7											
OUT8											
OUT9	14–17	15–18	0	Open-drain output 8 to 11, LED ON at low							
OUT10	14-17	01-01	15-16		Open-drain output o to TT, LED ON at low						
OUT11											
OUT12											
OUT13	19–22	20–23	0	Open-drain output 12 to 15, LED ON at low							
OUT14	19-22	20-23	0	Open-drain output 12 to 15, LED ON at low							
OUT15											
RESET	24	25	I	Active-low reset input							
SCL	25	26	I	Serial clock input							
SDA	26	27	I/O	Serial data input/output							
V _{CC}	27	28	-	Power supply							

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (see (1))

			MIN	MAX	UNIT
V_{CC}	Supply voltage		0	7	V
VI	Input voltage		-0.4	7	V
Vo	Output voltage		-0.5	20	V
I _O	Continuous output current per channel			120	mA
P_D	Power dissipation ($T_A = 25^{\circ}C$, JESD 51-7)	PW package		1.6	W
TJ	Junction temperature		-40	150	°C
T _{stg}	Storage temperature		-55	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
V	Electrostatic	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±1500	V
V _{(E}	(SD) discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	±500	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted) (see ⁽¹⁾)

				MIN	MAX	UNIT
V_{CC}	Supply voltage			3	5.5	V
V _{IH}	High-level input voltage	SCL, SDA, RESE	Γ, A0, A1, A2, A3	$V_{CC} \times 0.7$	V _{CC}	V
V _{IL}	Low-level input voltage	SCL, SDA, RESE	Γ, A0, A1, A2, A3	0	$V_{CC} \times 0.3$	V
Vo	Output voltage	OUT0-OUT15			17	V
		SDA	$V_{CC} = 3 V$		20	
IOL	Low-level output current	SDA	$V_{CC} = 5 V$		30	mA
I _O	Output current per channel	OUT0-OUT15			120	mA
T _A	Operating free-air temperature			-40	85	°C

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

6.4 Thermal Information

		TLC	TLC59116F		
	THERMAL METRIC ⁽¹⁾	PW (TSSOP)	RHB (VQFN)	UNIT	
		28 PINS	32 PINS		
$R_{\theta JA}$	Junction-to-ambient thermal resistance	78	34.4	°C/W	
R _{0JC(top)}	Junction-to-case (top) thermal resistance	18.8	26.3	°C/W	
$R_{\theta JB}$	Junction-to-board thermal resistance	36	8.3	°C/W	
Ψ_{JT}	Junction-to-top characterization parameter	0.5	0.4	°C/W	
Ψ _{JB}	Junction-to-board characterization parameter	35.5	8.2	°C/W	
R _{0JC(bot)}	Junction-to-case (bottom) thermal resistance	_	3.3	°C/W	

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.



6.5 Electrical Characteristics

 V_{CC} = 3 V to 5.5 V, T_A = -40°C to 85°C (unless otherwise noted)

	PARA	METER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
ار	Input/output leakage current	SCL, SDA, <u>A0, A1,</u> A2, A3, RESET	V _I = V _{CC} or GND			±0.3	μΑ
	Output leakage current	OUT0-OUT15	$V_{O} = 17 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$			0.5	μA
V _{POR}	Power-on reset voltage	·			2.5		V
-	Low-level output	SDA	$V_{CC} = 3 \text{ V}, \text{ V}_{OL} = 0.4 \text{ V}$	20			
OL	I _{OL} current	SDA	$V_{CC} = 5 \text{ V}, \text{ V}_{OL} = 0.4 \text{ V}$	30			mA
V	Low-level output	OUT0-OUT15	$V_{CC} = 3 V, I_{OL} = 120 mA$		200	450	mV
V _{OL}	voltage	0010-00115	$V_{CC} = 4.5 \text{ V}, I_{OL} = 120 \text{ mA}$		175	400	шv
1	On registeres	OUT0-OUT15	$V_{CC} = 3 V, I_{OL} = 120 mA$		1.67	3.75	Ω
r _{ON}	On resistance	0010-00115	$V_{CC} = 4.5 \text{ V}, I_{OL} = 120 \text{ mA}$		1.46	3.3	Ω
T _{SD}	Overtemperature shutdo	wn ⁽²⁾		150	175	200	°C
T _{HYS}	Restart hysteresis				15		°C
Ci	Input capacitance	SCL, A0, A1, A2, A3, RESET	$V_I = V_{CC}$ or GND		5		pF
Cio	Input/output capacitance	SDA	$V_{I} = V_{CC}$ or GND		8		pF
I _{CC}	Supply current	OUT0-OUT15 = OFF	V _{CC} = 5.5 V			13	mA

(1) All typical values are at $T_J = 25^{\circ}C$. (2) Specified by design; not production tested.

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6.6 I²C Interface Bus Timing Requirements

 $T_A = -40^{\circ}C$ to $85^{\circ}C$

	PARAMETER	STANDARD I ² C BL		FAST-MODE I ² C BUS	E	FAST-MODE I ² C BU		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
I ² C Inter	face		·					
f _{SCL}	SCL clock frequency	0	100	0	400	0	1000	kHz
t _{BUF}	Bus free time between a STOP and START condition	4.7		1.3		0.5		μs
t _{HD;STA}	Hold time (repeated) START condition	4		0.6		0.26		μs
t _{SU;STA}	Set-up time for a (repeated) START condition	1.7		0.6		0.26		μs
t _{su;sтo}	Set-up time for STOP condition	4		0.6		0.26		μs
t _{HD;DAT}	Data hold time	0		0		0		ns
t _{VD;ACK}	Data valid acknowledge time (1)	0.3	3.45	0.1	0.9	0.05	0.45	μs
t _{VD;DAT}	Data valid time (2)	0.3	3.45	0.1	0.9	0.05	0.45	μs
t _{SU;DAT}	Data set-up time	250		100		50		ns
t _{LOW}	Low period of the SCL clock	4.7		1.3		0.5		μs
t _{HIGH}	High period of the SCL clock	4		0.6		0.26		μs
t _f	Fall times of both SDA and SCL signals $^{\rm (3)}$ $^{\rm (4)}$		300	$20 + 0.1C_{b}$ ⁽⁵⁾	300		120	ns
t _r	Rise time of both SDA and SCL signals		1000	20 + 0.1C _b ⁽⁵⁾	300		120	ns
t _{SP}	Pulse width of spikes that must be suppressed by the input filter ⁽⁶⁾		50		50		50	ns
Reset							·	
t _W	Reset pulse width	10		10		10		ns
t _{REC}	Reset recovery time	0		0		0		ns
t _{RESET}	Time to reset ⁽⁷⁾ ⁽⁸⁾	400		400		400		ns

(1) $t_{VD;ACK}$ = time for acknowledgment signal from SCL low to SDA (out) low.

(2) $t_{VD;DAT}$ = minimum time for SDA data out to be valid following SCL low.

(3) A master device must internally provide a hold time of at least 300 ns for the SDA signal (refer to the V_{IL} of the SCL signal) in order to bridge the undefined region of SCL's falling edge.

(4) The maximum t_f for the SDA and SCL bus lines is specified at 300 ns. The maximum fall time (t_f) for the SDA output stage is specified at 250 ns. This allows series protection resistors to be connected between the SDA and the SCL pins and the SDA/SCL bus lines without exceeding the maximum specified t_f.

(5) $C_b = total capacitance of one bus line in pF.$

(6) Input filters on the SDA and SCL inputs suppress noise spikes less than 50 ns.

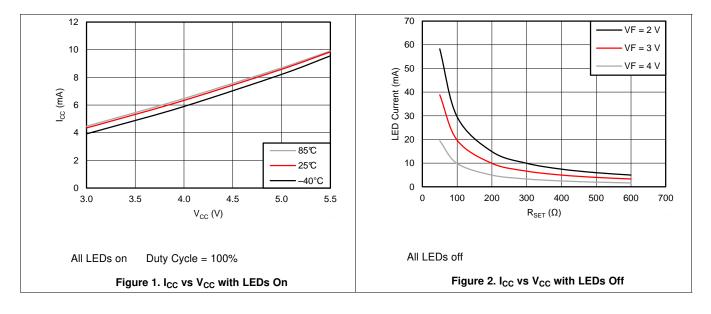
(7) Resetting the device while actively communicating on the bus may cause glitches or errant STOP conditions.

(8) Upon reset, the full delay will be the sum of t_{RESET} and the RC time constant of the SDA bus.

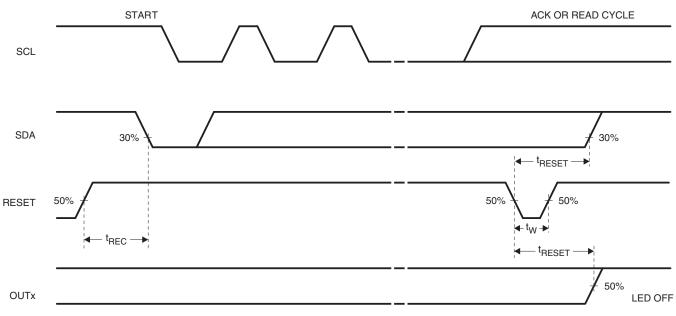
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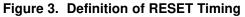


6.7 Typical Characteristics









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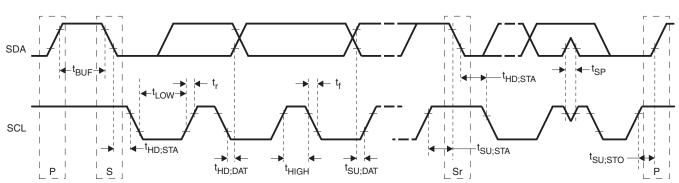
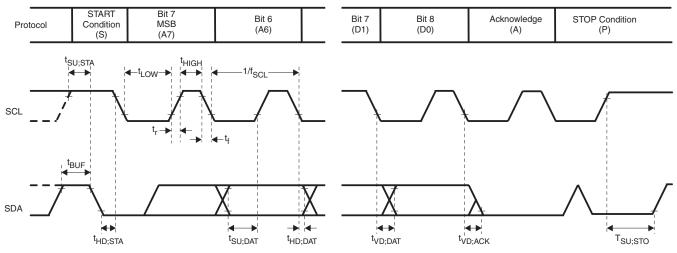
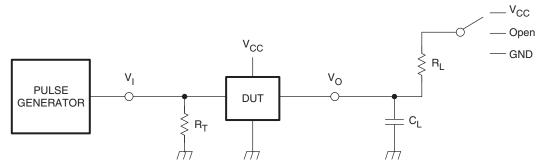


Figure 4. Definition of Timing



A. Rise and fall times refer to V_{IL} and $V_{IH}.$

Figure 5. I²C Bus Timing



- A. Load resistor, R_L, for SDA and SCL > 1 k Ω (3 mA or less current)
- B. Load capacitance, C_L , includes jig and probe capacitance
 - Termination resistance, R_T , should be equal to the output impedance Z_O of the pulse generators.

Figure 6. Test Circuit for Switching Characteristics

C.



8 Detailed Description

8.1 Overview

The TLC59116F is an I²C-bus controlled 16-channel LED driver optimized for red/green/blue/amber (RGBA) color mixing applications. Each LED output has its own 8-bit resolution (256 steps) fixed frequency individual PWM controller that operates at 97 kHz with a duty cycle that is adjustable from 0% to 99.6% to allow the LED to be set to a specific brightness value. An additional 8-bit resolution (256 steps) group PWM controller has both a fixed frequency of 190 Hz and an adjustable frequency between 24 Hz to once every 10.73 seconds with a duty cycle that is adjustable from 0% to 99.6% that is used to either dim or blink all LEDs with the same value.

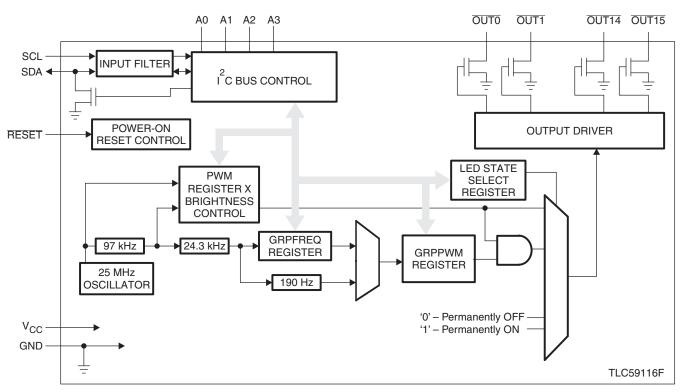
Each LED output can be off, on (no PWM control), set at its individual PWM controller value or at both individual and group PWM controller values. The TLC59116F operates with a supply voltage range of 3 V to 5.5 V and the outputs are 17-V tolerant. LEDs can be directly connected to the TLC59116F device outputs.

Software programmable LED group and three sub call I²C bus addresses allow all or defined groups of TLC59116F devices to respond to a common I²C bus address, which allows, for example, all the same color LEDs to be turned on or off at the same time or marquee chasing effect, thus minimizing I²C bus commands.

Four hardware address pins allow up to 14 devices on the same bus.

The software reset (SWRST) call allows the master to perform a reset of the TLC59116F through the I^2C bus, identical to the power-on reset (POR) that initializes the registers to their default state causing the outputs to be set high (LED off). This allows an easy and quick way to reconfigure all device registers to the same condition.

8.2 Functional Block Diagram



Only one PWM shown for clarity.



8.3 Feature Description

8.3.1 Power-On Reset (POR)

When power is applied to V_{CC} , an internal power-on reset holds the TLC59116F in a reset condition until V_{CC} reaches V_{POR} . At this point, the reset condition is released and the TLC59116F registers and I²C bus state machine are initialized to their default states causing all the channels to be deselected. Thereafter, V_{CC} must be lowered below 0.2 V to reset the device.

8.3.2 External Reset

A reset can be accomplished by holding the RESET pin low for a minimum of t_w. The TLC59116F registers and I²C state machine will be held in their default state until the RESET input is once again high.

This input requires a pullup resistor to V_{CC} if no active connection is used.

8.3.3 Software Reset

The software reset call (SWRST Call) allows all the devices in the l^2C bus to be reset to the power-up state value through a specific formatted l^2C bus command. To be performed correctly, it implies that the l^2C bus is functional and that there is no device hanging the bus.

The SWRST Call function is defined as the following:

- A START command is sent by the I²C bus master.
- The reserved SWRST I²C bus address '1101 011' with the R/W bit set to '0' (write) is sent by the I²C bus master.
- The TLC59116F device(s) acknowledge(s) after seeing the SWRST Call address '1101 0110' (D6h) only. If the R/W bit is set to '1' (read), no acknowledge is returned to the I²C bus master.
- Once the SWRST Call address has been sent and acknowledged, the master sends 2 bytes with 2 specific values (SWRST data byte 1 and byte 2):
 - a. Byte1 = A5h: the TLC59116F acknowledges this value only. If byte 1 is not equal to A5h, the TLC59116F does not acknowledge it.
 - b. Byte 2 = 5Ah: the TLC59116F acknowledges this value only. If byte 2 is not equal to 5Ah, the TLC59116F does not acknowledge it.

If more than 2 bytes of data are sent, the TLC59116F does not acknowledge any more.

Once the right 2 bytes (SWRST data byte 1 and byte 2 only) have been sent and correctly acknowledged, the
master sends a STOP command to end the SWRST Call: the TLC59116F then resets to the default value
(power-up value) and is ready to be addressed again within the specified bus free time (t_{BUF}).

The I²C bus master must interpret a non-acknowledge from the TLC59116F (at any time) as a *SWRST Call Abort*. The TLC59116F does not initiate a reset of its registers. This happens only when the format of the START Call sequence is not correct.

8.3.4 Individual Brightness Control With Group Dimming/Blinking

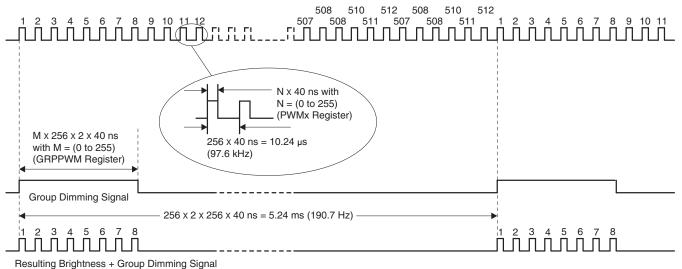
A 97-kHz fixed frequency signal with programmable duty cycle (8 bits, 256 steps) is used to control individually the brightness for each LED.

On top of this signal, one of the following signals can be superimposed (this signal can be applied to the 4 LED outputs):

- A lower 190-Hz fixed frequency signal with programmable duty cycle (8 bits, 256 steps) is used to provide a global brightness control.
- A programmable frequency signal from 24 Hz to 1/10.73 s (8 bits, 256 steps) is used to provide a global blinking control.



Feature Description (continued)



- A. Minimum pulse width for LEDn brightness control is 40 ns.
- B. Minimum pulse width for group dimming is 20.48 $\mu s.$
- C. When M = 1 (GRPPWM register value), the resulting LEDn brightness control and group dimming signal will have two pulses of the LED brightness control signal (pulse width = $N \times 40$ ns, with N defined in the PWMx register).
- D. The resulting brightness plus group dimming signal shown above demonstrate a resulting control signal with M = 4 (8 pulses).

Figure 7. Brightness and Group Dimming Signals

8.4 Device Functional Modes

8.4.1 Active

Active mode occurs when one or more of the output channels is enabled.

8.4.2 Standby

Standby mode occurs when all output channels are disabled. Standby mode may be entered either through I²C command or by pulling the RESET pin low.

8.5 Programming

8.5.1 Device Address

Following a START condition, the bus master outputs the address of the slave it is accessing.

8.5.2 Regular I²C Bus Slave Address

The I²C bus slave address of the TLC59116F is shown in Figure 8. To conserve power, no internal pullup resistors are incorporated on the hardware-selectable address pins, and they must be pulled high or low.

For buffer management purpose, a set of sector information data should be stored in a certain buffer.

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Programming (continued)

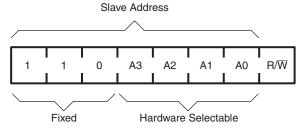


Figure 8. Slave Address

The last bit of the address byte defines the operation to be performed. When set to logic 1, a read is selected; a logic 0 selects a write operation.

8.5.3 LED All-Call I²C Bus Address

- Default power-up value (ALLCALLADR register): D0h or 1101 000
- Programmable through I²C bus (volatile programming)
- At power-up, LED All Call I²C bus address is enabled. TLC59116F sends an ACK when D0h ($R/\overline{W} = 0$) or D1h ($R/\overline{W} = 1$) is sent by the master.

See *Register Descriptions* for more details.

NOTE

The default LED all-call I^2C bus address (D0h or 1101 000) must not be used as a regular I^2C bus slave address since this address is enabled at power-up. All the TLC59116Fs on the I^2C bus will acknowledge the address if sent by the I^2C bus master.

8.5.4 LED Sub-Call I²C Bus Address

- Three different I²C bus addresses can be used.
- Default power-up values:
 - SUBADR1 register: D2h or 1101 001
 - SUBADR2 register: D4h or 1101 010
 - SUBADR3 register: D8h or 1101 100
- Programmable through I²C bus (volatile programming)
- At power-up, sub-call I²C bus address is disabled. TLC59116F does not send an ACK when D2h (R/W = 0) or D3h (R/W = 1) or D4h (R/W = 0) or D5h (R/W = 1) or D8h (R/W = 0) or D9h (R/W = 1) is sent by the master.

See *Register Descriptions* for more details.

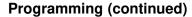
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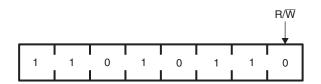
The default LED Sub Call I^2C bus address may be used as a regular I^2C bus slave address as long as the Sub Call addresses are disabled in MODE1 (default).

8.5.5 Software Reset I²C Bus Address

The address shown in Figure 9 is used when a reset of the TLC59116F needs to be performed by the master. The Software Reset address (SWRST Call) must be used with R/W = 0. If R/W = 1, the TLC59116F does not acknowledge the SWRST. See *Register Descriptions* for more details.







The software reset I²C bus address is reserved address and cannot be use as regular I²C bus slave address or as an LED All-Call or LED Sub-Call address.

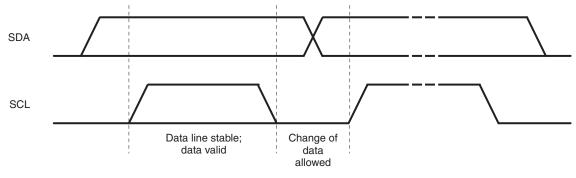
Figure 9. Software Reset Address

8.5.6 Characteristics of the I²C Bus

The I²C bus is for two-way, two-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply through a pullup resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

8.5.6.1 Bit Transfer

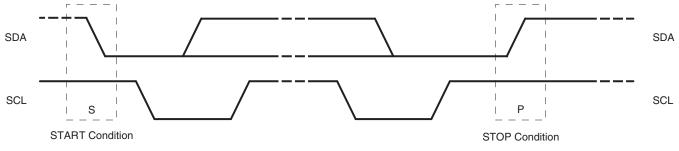
One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the high period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 10).





8.5.6.2 START and STOP Conditions

Both data and clock lines remain high when the bus is not busy. A high-to-low transition of the data line while the clock is high is defined as the START condition (S). A low-to-high transition of the data line while the clock is high is defined as the STOP condition (P) (see Figure 11).





Programming (continued)

8.5.6.3 System Configuration

A device generating a message is a transmitter; a device receiving is the receiver. The device that controls the message is the master and the devices controlled by the master are the slaves (see Figure 12).

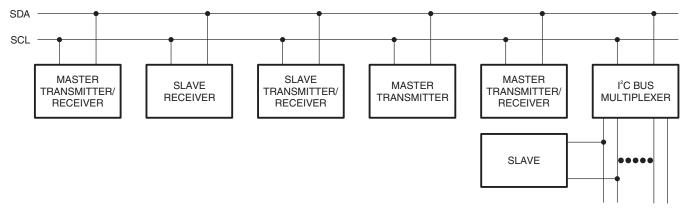


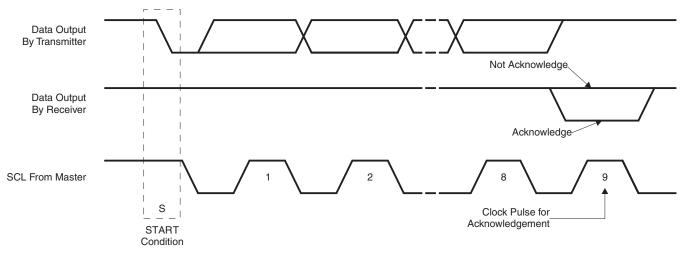
Figure 12. System Configuration

8.5.6.4 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a high level put on the bus by the transmitter, whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable low during the high period of the acknowledge related clock pulse; set-up time and hold time must be taken into account.

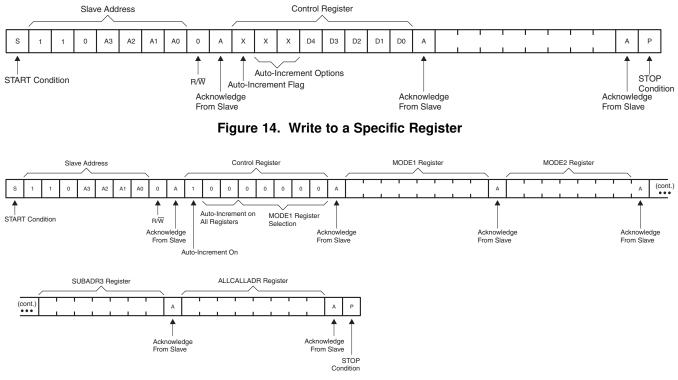
A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line high to enable the master to generate a STOP condition.







Programming (continued)





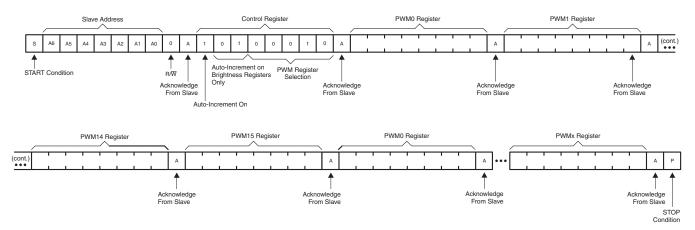


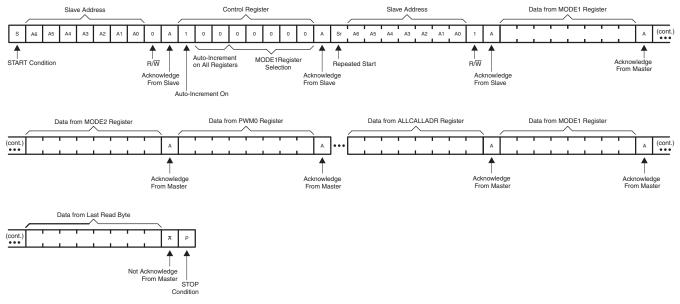
Figure 16. Multiple Writes to Individual Brightness Registers Only Using the Auto-Increment Feature

TLC59116F

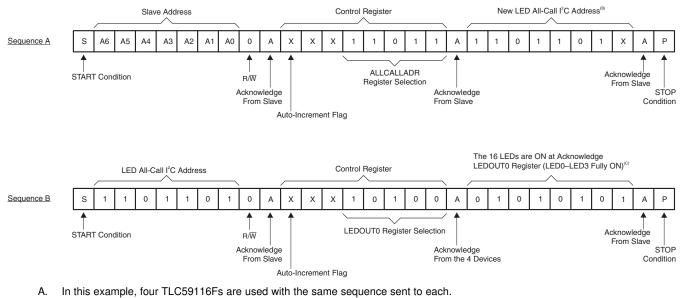
SCLS714C-MARCH 2009-REVISED SEPTEMBER 2015

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Programming (continued)







- B. ALLCALL bit in MODE1 register is equal to 1 for this example.
- C. OCH bit in MODE2 register is equal to 1 for this example.

Figure 18. LED All-Call I²C Bus Address Programming and LED All-Call Sequence Example

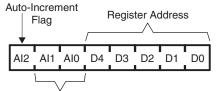
8.6 Register Maps

8.6.1 Control Register

Following the successful acknowledgment of the slave address, LED All Call address or LED Sub Call address, the bus master will send a byte to the TLC59116F, which will be stored in the Control register. The lowest 5 bits are used as a pointer to determine which register will be accessed (D[4:0]). The highest three bits are used as Auto-Increment flag and Auto-Increment options (AI[2:0]).



Register Maps (continued)



Auto-Increment Options

Figure 19. Control Register

When the Auto-Increment flag is set (AI2 = logic 1), the five low order bits of the Control register are automatically incremented after a read or write. This allows the user to program the registers sequentially. Four different types of Auto-Increment are possible, depending on AI1 and AI0 values.

Al2	Al1	AIO	PIN DESCRIPTION
0	0	0	No auto-increment
1	0	0	Auto-increment for all registers. D[4:0] roll over to 0 0000 after the last register (1 1011) is accessed.
1	0	1	Auto-increment for individual brightness registers only. D[4:0] roll over to 0 0010 after the last register (1 0001) is accessed.
1	1	0	Auto-increment for global control registers only. D[4:0] roll over to 1 0010 after the last register (1 0011) is accessed.
1	1	1	Auto-increment for individual and global control registers only. D[4:0] roll over to 0 0010 after the last register (1 0011) is accessed.

Table 1. Auto-Increment Options ⁽¹⁾

(1) Other combinations not shown in Table 1 (AI[2:0] = 001, 010 and 011) are reserved and must not be used for proper device operation.

AI[2:0] = 000 is used when the same register must be accessed several times during a single I²C bus communication (for example, changing the brightness of a single LED). Data is overwritten each time the register is accessed during a write operation.

AI[2:0] = 100 is used when all the registers must be sequentially accessed (for example, power-up programming).

AI[2:0] = 101 is used when the four LED drivers must be individually programmed with different values during the same I²C bus communication (for example, changing color setting to another color setting).

AI[2:0] = 110 is used when the LED drivers must be globally programmed with different settings during the same I^2C bus communication (for example, global brightness or blinking change).

AI[2:0] = 111 is used when individually and global changes must be performed during the same I²C bus communication (for example, changing color and global brightness at the same time).

Only the five least-significant bits (LSBs) D[4:0] are affected by the AI[2:0] bits.

When Control register is written, the register entry point determined by D[4:0] is the first register that will be addressed (read or write operation), and can be anywhere between 0 0000 and 1 1011 (as defined in). When AI[2] = 1, the Auto-Increment flag is set and the rollover value at which the point where the register increment stops and goes to the next one is determined by AI[2:0]. See for rollover values. For example, if the Control register = 1111 0100 (F4h), then the register addressing sequence will be (in hex):

TEXAS INSTRUMENTS

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8.6.2 Register Descriptions

REGISTER NUMBER (HEX)NAMEACCESS ⁽¹⁾ FUNCTION00MODE1R/WMode register 101MODE2R/WMode register 202PWM0R/WBrightness control LED003PWM1R/WBrightness control LED104PWM2R/WBrightness control LED205PWM3R/WBrightness control LED206PWM4R/WBrightness control LED306PWM4R/WBrightness control LED407PWM5R/WBrightness control LED508PWM6R/WBrightness control LED609PWM7R/WBrightness control LED609PWM9R/WBrightness control LED609PWM9R/WBrightness control LED600PWM9R/WBrightness control LED601PWM9R/WBrightness control LED605PWM9R/WBrightness control LED1006PWM9R/WBrightness control LED1407PWM11R/WBrightness control LED1408PWM9R/WBrightness control LED1409PWM12R/WBrightness control LED1400PWM13R/WBrightness control LED1401PWM14R/WBrightness control LED1405PWM15R/WBrightness control LED1406PWM16R/WBrightness control LED1407PWM17R/WBrightness control LED1408<										
01MODE2R/WMode register 202PWM0R/WBrightness control LED003PWM1R/WBrightness control LED104PWM2R/WBrightness control LED205PWM3R/WBrightness control LED306PWM4R/WBrightness control LED407PWM5R/WBrightness control LED508PWM6R/WBrightness control LED508PWM6R/WBrightness control LED609PWM7R/WBrightness control LED70APWM8R/WBrightness control LED70APWM8R/WBrightness control LED60BPWM9R/WBrightness control LED100DPWM10R/WBrightness control LED110CPWM11R/WBrightness control LED110EPWM12R/WBrightness control LED110FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPFMEQR/WGroup duty cycle control13GRPFREQR/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WIED output state 318SUBADR1R/WIED output state 319SUBADR3R/WIPC bus sub-address 3		NAME	ACCESS ⁽¹⁾	FUNCTION						
02PWM0R/WBrightness control LED003PWM1R/WBrightness control LED104PWM2R/WBrightness control LED205PWM3R/WBrightness control LED306PWM4R/WBrightness control LED407PWM5R/WBrightness control LED508PWM6R/WBrightness control LED70APWM8R/WBrightness control LED70APWM8R/WBrightness control LED70APWM9R/WBrightness control LED90CPWM10R/WBrightness control LED100DPWM11R/WBrightness control LED110EPWM12R/WBrightness control LED110EPWM13R/WBrightness control LED110FPWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPFREQR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR3R/WI²C bus sub-address 3	00	MODE1	R/W	Mode register 1						
03PWM1R/WBrightness control LED104PWM2R/WBrightness control LED205PWM3R/WBrightness control LED306PWM4R/WBrightness control LED407PWM5R/WBrightness control LED608PWM6R/WBrightness control LED709PWM7R/WBrightness control LED70APWM8R/WBrightness control LED70APWM9R/WBrightness control LED90CPWM10R/WBrightness control LED10DPWM11R/WBrightness control LED110EPWM12R/WBrightness control LED120FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 118SUBADR1R/WI²C bus sub-address 21ASUBADR3R/WI²C bus sub-address 3	01	MODE2	R/W	Mode register 2						
04PWM2R/WBrightness control LED205PWM3R/WBrightness control LED306PWM4R/WBrightness control LED407PWM5R/WBrightness control LED508PWM6R/WBrightness control LED609PWM7R/WBrightness control LED70APWM8R/WBrightness control LED90BPWM9R/WBrightness control LED90CPWM10R/WBrightness control LED100DPWM11R/WBrightness control LED110EPWM12R/WBrightness control LED120FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1311PWM15R/WBrightness control LED1512GRPFREQR/WGroup duty cycle control13GRPFREQR/WGroup trequency14LEDOUT0R/WLED output state 116LEDOUT1R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	02	PWM0	R/W	Brightness control LED0						
05PWM3R/WBrightness control LED306PWM4R/WBrightness control LED407PWM5R/WBrightness control LED508PWM6R/WBrightness control LED609PWM7R/WBrightness control LED70APWM8R/WBrightness control LED80BPWM9R/WBrightness control LED90CPWM10R/WBrightness control LED100DPWM11R/WBrightness control LED110EPWM12R/WBrightness control LED120FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDUT1R/WLED output state 116LEDUT2R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR2R/WI ² C bus sub-address 3	03	PWM1	R/W	Brightness control LED1						
06PWM4R/WBrightness control LED407PWM5R/WBrightness control LED508PWM6R/WBrightness control LED609PWM7R/WBrightness control LED70APWM8R/WBrightness control LED70APWM9R/WBrightness control LED90CPWM10R/WBrightness control LED100DPWM11R/WBrightness control LED110EPWM12R/WBrightness control LED120FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1411PUM15R/WBrightness control LED1411PUM14R/WBrightness control LED1411PUM15R/WBrightness control LED1411PUM15R/WBrightness control LED1411PUM15R/WBrightness control LED1411PUM15R/WBrightness control LED1512GRPFREQR/WGroup drug cycle control13GRPFREQR/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR2R/WI ² C bus sub-address 3	04	PWM2	R/W	Brightness control LED2						
07PWM5R/WBrightness control LED508PWM6R/WBrightness control LED609PWM7R/WBrightness control LED70APWM8R/WBrightness control LED80BPWM9R/WBrightness control LED90CPWM10R/WBrightness control LED10DPWM11R/WBrightness control LED100DPWM12R/WBrightness control LED110EPWM13R/WBrightness control LED120FPWM14R/WBrightness control LED1310PWM15R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPFREQR/WGroup duty cycle control13GRPFREQR/WLED output state 015LEDOUT0R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	05	PWM3	R/W	Brightness control LED3						
08PWM6R/WBrightness control LED609PWM7R/WBrightness control LED70APWM8R/WBrightness control LED80BPWM9R/WBrightness control LED90CPWM10R/WBrightness control LED100DPWM11R/WBrightness control LED100EPWM12R/WBrightness control LED120FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR3R/WI²C bus sub-address 3	06	PWM4	R/W	Brightness control LED4						
09PWM7R/WBrightness control LED70APWM8R/WBrightness control LED80BPWM9R/WBrightness control LED90CPWM10R/WBrightness control LED100DPWM11R/WBrightness control LED100DPWM12R/WBrightness control LED110EPWM12R/WBrightness control LED120FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1512GRPPWMR/WBrightness control LED1513GRPFREQR/WGroup duty cycle control14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	07	PWM5	R/W	Brightness control LED5						
OAPWM8R/WBrightness control LED80BPWM9R/WBrightness control LED90CPWM10R/WBrightness control LED100DPWM11R/WBrightness control LED110EPWM12R/WBrightness control LED120FPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WBrightness control LED1513GRPFREQR/WGroup duty cycle control14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	08	PWM6	R/W	Brightness control LED6						
OBPWM9R/WBrightness control LED9OCPWM10R/WBrightness control LED10ODPWM11R/WBrightness control LED11OEPWM12R/WBrightness control LED12OFPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	09	PWM7	R/W	Brightness control LED7						
OCPWM10R/WBrightness control LED10ODPWM11R/WBrightness control LED11OEPWM12R/WBrightness control LED12OFPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 317LEDOUT3R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR3R/WI²C bus sub-address 3	0A	PWM8	R/W	Brightness control LED8						
ODPWM11R/WBrightness control LED11OEPWM12R/WBrightness control LED12OFPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 317LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	0B	PWM9	R/W	Brightness control LED9						
OEPWM12R/WBrightness control LED12OFPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	0C	PWM10	R/W	Brightness control LED10						
OFPWM13R/WBrightness control LED1310PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 317LEDOUT3R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR3R/WI²C bus sub-address 3	0D	PWM11	R/W	Brightness control LED11						
10PWM14R/WBrightness control LED1411PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	0E	PWM12	R/W	Brightness control LED12						
11PWM15R/WBrightness control LED1512GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR3R/WI ² C bus sub-address 3	0F	PWM13	R/W	Brightness control LED13						
12GRPPWMR/WGroup duty cycle control13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR2R/WI ² C bus sub-address 21ASUBADR3R/WI ² C bus sub-address 3	10	PWM14	R/W	Brightness control LED14						
13GRPFREQR/WGroup frequency14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI ² C bus sub-address 119SUBADR2R/WI ² C bus sub-address 21ASUBADR3R/WI ² C bus sub-address 3	11	PWM15	R/W	Brightness control LED15						
14LEDOUT0R/WLED output state 015LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR2R/WI²C bus sub-address 21ASUBADR3R/WI²C bus sub-address 3	12	GRPPWM	R/W	Group duty cycle control						
15LEDOUT1R/WLED output state 116LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR2R/WI²C bus sub-address 21ASUBADR3R/WI²C bus sub-address 3	13	GRPFREQ	R/W	Group frequency						
16LEDOUT2R/WLED output state 217LEDOUT3R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR2R/WI²C bus sub-address 21ASUBADR3R/WI²C bus sub-address 3	14	LEDOUT0	R/W	LED output state 0						
17LEDOUT3R/WLED output state 318SUBADR1R/WI²C bus sub-address 119SUBADR2R/WI²C bus sub-address 21ASUBADR3R/WI²C bus sub-address 3	15	LEDOUT1	R/W	LED output state 1						
18SUBADR1R/WI²C bus sub-address 119SUBADR2R/WI²C bus sub-address 21ASUBADR3R/WI²C bus sub-address 3	16	LEDOUT2	R/W	LED output state 2						
19 SUBADR2 R/W I ² C bus sub-address 2 1A SUBADR3 R/W I ² C bus sub-address 3	17	LEDOUT3	R/W	LED output state 3						
1A SUBADR3 R/W I ² C bus sub-address 3	18	SUBADR1	R/W	I ² C bus sub-address 1						
	19	SUBADR2	R/W	I ² C bus sub-address 2						
1B ALLCALLADR R/W LED All Call I ² C bus address	1A	SUBADR3	R/W	I ² C bus sub-address 3						
	1B	ALLCALLADR	R/W	LED All Call I ² C bus address						

Table 2. Register Descriptions

(1) R = read, W = write

8.6.2.1 Mode Register 1 (MODE1)

BIT	SYMBOL	ACCESS ⁽¹⁾	VALUE	DESCRIPTION				
7	AI2	R	0 ⁽²⁾	Register auto-increment disabled				
/	AIZ	n	1	Register auto-increment enabled				
0	A14	P	0 ⁽²⁾	Auto-increment bit 1 = 0				
6	Al1	R	1	Auto-increment bit 1 = 1				
F	410	P	0 ⁽²⁾	Auto-increment bit 0 = 0				
5	AIO	R	1	Auto-increment bit 0 = 1				
4		DAM	0	Normal mode ⁽³⁾				
4	4 SLEEP	R/W	1 (2)	Low-power mode. Oscillator off. ⁽⁴⁾				
0		R/W	0 ⁽²⁾	TLC59116F does not respond to I ² C bus sub-address 1.				
3	SUB1		1	TLC59116F responds to I ² C bus sub-address 1.				
2	CLIPO	DAA	0 ⁽²⁾	TLC59116F does not respond to I ² C bus sub-address 2.				
2	SUB2	R/W	1	TLC59116F responds to I ² C bus sub-address 2.				
4	CLIPS	DAA	0 ⁽²⁾	TLC59116F does not respond to I ² C bus sub-address 3.				
I	SUB3	R/W	1	TLC59116F responds to I ² C bus sub-address 3.				
0	ALLCALL	DAA	0	TLC59116F does not respond to LED all-call I ² C bus address.				
U		R/W	1 (2)	TLC59116F responds to LED all-call I ² C bus address.				

Table 3. MODE1 – Mode Register 1 (Address 00h) Bit Description

(1) R = read, W = write

(2) Default value

(3) It takes 500 μs max for the oscillator to be up and running once SLEEP bit has been set from logic 1 to 0. Timings on LEDn outputs are not guaranteed if PWMx, GRPPWM, or GRPFREQ registers are accessed within the 500-μs window.

(4) No LED control including ON/OFF, blinking and dimming is possible when oscillator is off. Writing to the register during SLEEP mode does not affect LED condition. It is needed to set the SLEEP bit to logic 0 when LED condition is required to change.

8.6.2.2 Mode Register 2 (MODE2)

BIT	SYMBOL	ACCESS (1)	VALUE	DESCRIPTION
7:6		R	00 (2)	Reserved
5	DMBLNK	R/W	0 ⁽²⁾	Group control = dimming
5			1	Group control = blinking
4		R	0 (2)	Reserved
3	ОСН	R/W	0 ⁽²⁾	Outputs change on STOP command ⁽³⁾
3	UCH		1	Outputs change on ACK
2:0		R	000 (2)	Reserved

(1) R = read, W = write

(2) Default value(3) Change of the

 Change of the outputs at the STOP command allows synchronizing outputs of more than one TLC59116F. Applicable to registers from 02h (PWM0) to 17h (LEDOUT) only.

NSTRUMENTS

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8.6.2.3 Individual Brightness Control (PWM0–PWM15) Registers

Table 5. PWM0–PWM15 – Individual Brightness Control Registers (Address 02h to 11h) Bit Description

				-		
ADDRESS	REGISTER	BIT	SYMBOL	ACCESS ⁽¹⁾	VALUE ⁽²⁾	DESCRIPTION
02h	PWM0	7:0	IDC0[7:0]	R/W	0000 0000	PWM0 individual duty cycle
03h	PWM1	7:0	IDC1[7:0]	R/W	0000 0000	PWM1 individual duty cycle
04h	PWM2	7:0	IDC2[7:0]	R/W	0000 0000	PWM2 individual duty cycle
05h	PWM3	7:0	IDC3[7:0]	R/W	0000 0000	PWM3 individual duty cycle
06h	PWM4	7:0	IDC4[7:0]	R/W	0000 0000	PWM4 individual duty cycle
07h	PWM5	7:0	IDC5[7:0]	R/W	0000 0000	PWM5 individual duty cycle
08h	PWM6	7:0	IDC6[7:0]	R/W	0000 0000	PWM6 individual duty cycle
09h	PWM7	7:0	IDC7[7:0]	R/W	0000 0000	PWM7 individual duty cycle
0Ah	PWM8	7:0	IDC8[7:0]	R/W	0000 0000	PWM8 individual duty cycle
0Bh	PWM9	7:0	IDC9[7:0]	R/W	0000 0000	PWM9 individual duty cycle
0Ch	PWM10	7:0	IDC10[7:0]	R/W	0000 0000	PWM10 individual duty cycle
0Dh	PWM11	7:0	IDC11[7:0]	R/W	0000 0000	PWM11 individual duty cycle
0Eh	PWM12	7:0	IDC12[7:0]	R/W	0000 0000	PWM12 individual duty cycle
0Fh	PWM13	7:0	IDC13[7:0]	R/W	0000 0000	PWM13 individual duty cycle
10h	PWM14	7:0	IDC14[7:0]	R/W	0000 0000	PWM14 individual duty cycle
11h	PWM15	7:0	IDC15[7:0]	R/W	0000 0000	PWM15 individual duty cycle

(1) R = read, W = write

(2) Default value

A 97-kHz fixed frequency signal is used for each output. Duty cycle is controlled through 256 linear steps from 00h (0% duty cycle = LED output off) to FFh (99.6% duty cycle = LED output at maximum brightness). Applicable to LED outputs programmed with LDRx = 10 or 11 (LEDOUT0 to LEDOUT3 registers).

256

(1)

8.6.2.4 Group Duty Cycle Control (GRPPWM) Register

Table 6. GRPPWM – Group Duty Cycle Control Register (Address 12h) Bit Description

ADDRESS	REGISTER	BIT	SYMBOL	ACCESS (1)	VALUE ⁽²⁾	DESCRIPTION
12h	GRPPWM	7:0	GDC0[7:0]	R/W	1111 1111	GRPPWM register

(1) R = read, W = write

(2) Default value

When DMBLNK bit (MODE2 register) is programmed with logic 0, a 190-Hz fixed frequency signal is superimposed with the 97-kHz individual brightness control signal. GRPPWM is then used as a global brightness control allowing the LED outputs to be dimmed with the same value.

NOTE

The value in GRPFREQ has to be programmed to 00h when DMBLNK = 0.

General brightness for the 16 outputs is controlled through 256 linear steps from 00h (0% duty cycle = LED output off) to FFh (99.6% duty cycle = maximum brightness). Applicable to LED outputs programmed with LDRx = 11 (LEDOUT0 to LEDOUT3 registers).

When DMBLNK bit is programmed with logic 1, GRPPWM and GRPFREQ registers define a global blinking pattern, where GRPFREQ contains the blinking period (from 24 Hz to 10.73 s) and GRPPWM the duty cycle (ON/OFF ratio in percentages).

Duty cycle = GDC[7:0]

256

8.6.2.5 Group Frequency (GRPFREQ) Register

ADDRESS	REGISTER	BIT	SYMBOL	ACCESS ⁽¹⁾	VALUE ⁽²⁾	DESCRIPTION
13h	GRPFREQ	7:0	GFRQ[7:0]	R/W	0000 0000	GRPFREQ register

(1) R = read, W = write

(2) Default value

GRPFREQ is used to program the global blinking period when DMBLNK bit (MODE2 register) is equal to 1.

NOTE The value in GRPFREQ must be programmed to 00h when DMBLNK = 0.

Applicable to LED output programmed with LDRx = 11 (LEDOUT0 to LEDOUT3 registers). Blinking period is controlled through 256 linear steps from 00h (41 ms, frequency 24 Hz) to FFh (10.73 s).

Global blinking period = $\frac{\text{GFRQ}[7:0] + 1}{24}$ (s)

(3)

8.6.2.6 LED Driver Output State (LEDOUT0-LEDOUT3) Register

Table 8. LEDOUT0-LEDOUT3 - LED Driver Output State Registers (Address 14h-17h) Bit Description

ADDRESS	REGISTER	BIT	SYMBOL	ACCESS (1)	VALUE ⁽²⁾	DESCRIPTION
		7:6	LDR3[1:0]	R/W	00	LED3 output state control
14h	LEDOUT0	5:4	LDR2[1:0]	R/W	00	LED2 output state control
14(1	LEDUUTU	3:2	LDR1[1:0]	R/W	00	LED1 output state control
		1:0	LDR0[1:0]	R/W	00	LED0 output state control
		7:6	LDR7[1:0]	R/W	00	LED7 output state control
15h	LEDOUT1	5:4	LDR6[1:0]	R/W	00	LED6 output state control
1011	LEDOUTI	3:2	LDR5[1:0]	R/W	00	LED5 output state control
		1:0	LDR4[1:0]	R/W	00	LED4 output state control
		7:6	LDR11[1:0]	R/W	00	LED11 output state control
16h	LEDOUT2	5:4	LDR10[1:0]	R/W	00	LED10 output state control
1011	LEDUUIZ	3:2	LDR9[1:0]	R/W	00	LED9 output state control
		1:0	LDR8[1:0]	R/W	00	LED8 output state control
		7:6	LDR15[1:0]	R/W	00	LED15 output state control
17h		5:4	LDR14[1:0]	R/W	00	LED14 output state control
1711	LEDOUT3	3:2	LDR13[1:0]	R/W	00	LED13 output state control
		1:0	LDR12[1:0]	R/W	00	LED12 output state control

(1) R = read, W = write

(2) Default value

LDRx = 00 : LED driver x is off (default power-up state).

LDRx = 01 : LED driver x is fully on (individual brightness and group dimming/blinking not controlled).

LDRx = 10: LED driver x is individual brightness can be controlled through its PWMx register.

LDRx = 11 : LED driver x is individual brightness and group dimming/blinking can be controlled through its PWMx register and the GRPPWM registers.

8.6.2.7 PC Bus Sub-Address 1 to 3 (SUBADR1–SUBADR3) Register

Table 9. SUBADR1–SUBADR3 – I²C Bus Sub-Address Registers (Address 18h–1Ah) Bit Description

ADDRESS	REGISTER	BIT	SYMBOL	ACCESS (1)	VALUE ⁽²⁾	DESCRIPTION
		7:5	A1[7:5]	R	110	
18h	SUBADR1	4:1	A1[4:1]	R/W	1001	I ² C bus sub-address 1
		0	A1[0]	R	0	
	SUBADR2	7:5	A2[7:5]	R	110	
19h		4:1	A2[4:1]	R/W	1010	I ² C bus sub-address 2
		0	A2[0]	R	0	
		7:5	A3[7:5]	R	110	
1Ah	SUBADR3	4:1	A31[4:1]	R/W	1100	I ² C bus sub-address 3
		0	A3[0]	R	0	

(1) R = read, W = write

(2) Default value

Sub-addresses are programmable through the I²C bus. Default power-up values are D2h, D4h, D8h and the device(s) will not acknowledge these addresses right after power-up (the corresponding SUBx bit in MODE1 register is equal to 0).

Once sub-addresses have been programmed to their right values, SUBx bits need to be set to 1 in order to have the device acknowledging these addresses (MODE1 register).

Only the 7 MSBs representing the I²C bus sub-address are valid. The LSB in SUBADRx register is a read-only bit (0).

When SUBx is set to 1, the corresponding I^2C bus sub-address can be used during either an I^2C -bus read or write sequence.

8.6.2.8 LED All-Call I²C Bus Address (ALLCALLADR) Register

ADDRESS	REGISTER	BIT	SYMBOL	ACCESS (1)	VALUE ⁽²⁾	DESCRIPTION
		7:5	AC[7:5]	R	110	
1Bh	1Bh ALLCALLA DR	4:1	AC[4:1]	R/W	1000	ALLCALLADR I ² C bus address register
	BIT	0	AC[0]	R	0	

Table 10. ALLCALLADR – All-Call I ² C Bus A	Address Register (Address 1Bh) Bit Description
--	--

(1) R = read, W = write

(2) Default value

The LED All Call I²C bus address allows all the TLC59116Fs in the bus to be programmed at the same time (ALLCALL bit I²C-bus read or write sequence in register MODE1 must be equal to 1 (power-up default state)). This address is programmable through the I²C bus and can be used during either an I²C-bus read or write sequence. The register address can also be programmed as a Sub Call.

Only the 7 MSBs representing the All Call I²C bus address are valid. The LSB in ALLCALLADR register is a read-only bit (0).

If ALLCALL bit = 0 (MODE1), the device does not acknowledge the address programmed in register ALLCALLADR.



9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

This section highlights some of the design considerations for implementing this device in various applications.

9.1.1 Setting LED Current

The LED current is primarily dependent on the supply voltage, the forward voltage of the LED, and the series resistor (R_{SET}). In many applications the supply voltage and LED forward voltage cannot be adjusted. Hence, R_{SET} is utilized to adjust the LED current. This calculation is discussed in detail in the typical application example.

9.1.2 PWM Brightness Dimming

The perceived brightness of the LEDs can be adjusted by use of PWM dimming. For example, an LED driven at 50% duty cycle will appear less bright than it would at 100% duty cycle. The TLC59116F offers duty cycle control for each individual channel and also offers group duty cycle control. Refer to the Register Map for details regarding programmable duty cycle.

TLC59116F

SCLS714C - MARCH 2009 - REVISED SEPTEMBER 2015

9.2 Typical Application

This application example provides guidance on how to set the LED current using the TLC59116F.

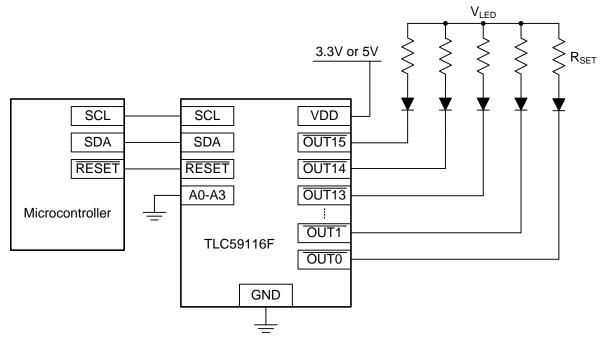


Figure 20. Typical Application Schematic

9.2.1 Design Requirements

For this design example, use the following as the input parameters.

Table 11	I. Design	Parameters
----------	-----------	------------

	DESIGN PARAMETER	EXAMPLE VALUE			
V _{LED}	V _{LED} Supply voltage that powers the LED				
V _F	Forward voltage across the LED	3 V			
I _{LED}	Current flowing through the LED	6 mA			
R _{ON}	Resistance across open-drain output	1.5 Ω			

9.2.2 Detailed Design Procedure

In the LED current path, there are three voltage drops that must be considered:

- Drop across the series resistor (V_{RSET})
- Drop across the LED (V_F)
- Drop across the open-drain output channel (V_O)

The drop across the LED is defined above as VF = 3V. The drop across the open-drain output is calculated as $R_{ON} \times I_{LED}$ (1.5 $\Omega \times 0.006$ A = 0.009 V). The remaining voltage must be across the series resistor:

 $5 V = 3 V + 0.009 V + V_{RSET}$

• V_{RSET} = 1.991 V

After calculating $V_{\text{RSET}},$ we can calculate R_{SET} :

 $V_{RSET} = I_{LED} \times R_{SET}$

- 1.991V = 0.006 mA × R_{SET}
- R_{SET} = 332 Ω

(5)

(4)



9.2.3 Application Curve

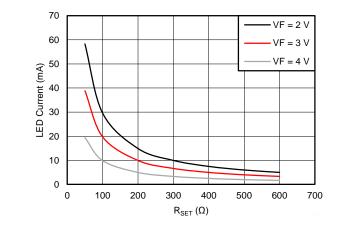




Figure 21. Typical LED Current as a Function of R_{SET} and V_F



10 Power Supply Recommendations

TLC59116F is designed to operate from a VCC range of 3 V to 5.5 V. The system will also require a power supply for the LEDs. The supply voltage for the LEDs must be greater than the forward voltage of the LED plus the V_{OL} of the channel.

11 Layout

11.1 Layout Guidelines

The I²C signals (SDA / SCL) should be kept away from potential noise sources.

The traces carrying power through the LEDS should be wide enough to the handle necessary current.

All LED current passes through the device and into the ground node. There must be a strong connection between the device ground and the circuit board ground. For the RHB package, the thermal pad should be connected to ground to help dissipate heat.

11.2 Layout Examples

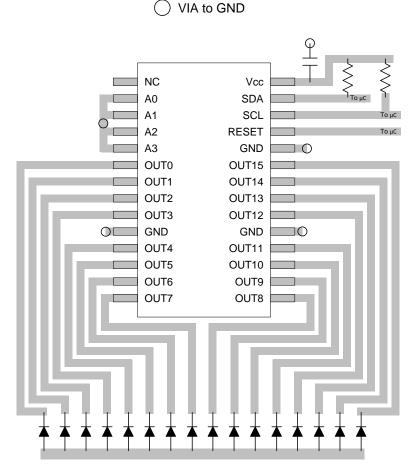


Figure 22. PW Layout Example



Layout Examples (continued)

◯ VIA to GND

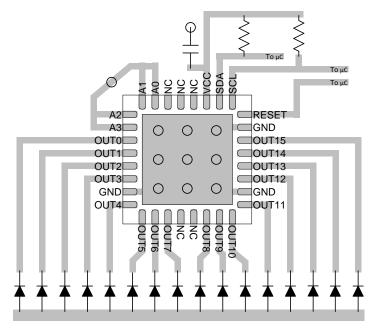


Figure 23. RHB Layout Example



12 Device and Documentation Support

12.1 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E[™] Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.2 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

12.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLC59116FIPWR	ACTIVE	TSSOP	PW	28	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y59116F	Samples
TLC59116FIRHBR	ACTIVE	VQFN	RHB	32	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	FL116F	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

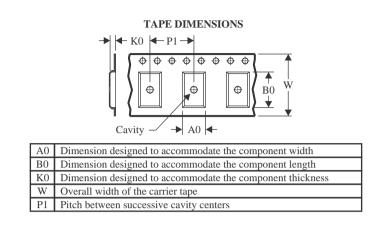


Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	-	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC59116FIPWR	TSSOP	PW	28	2000	330.0	16.4	6.9	10.2	1.8	12.0	16.0	Q1
TLC59116FIRHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.5	8.0	12.0	Q2



PACKAGE MATERIALS INFORMATION

3-Jun-2022

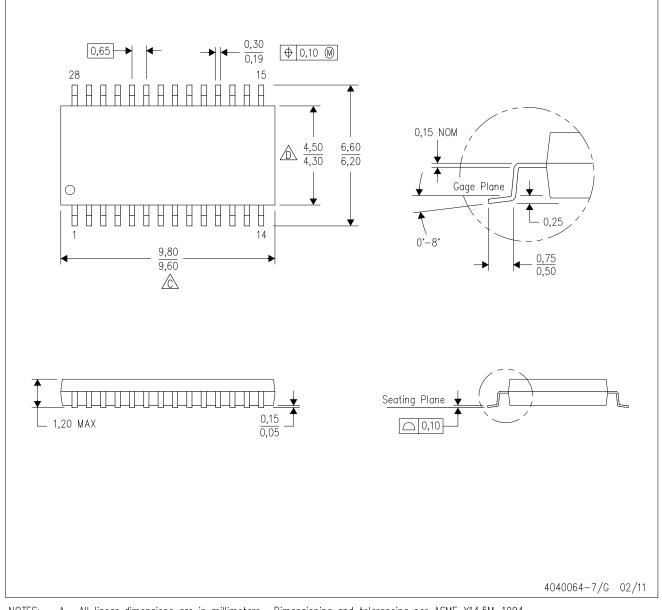


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC59116FIPWR	TSSOP	PW	28	2000	356.0	356.0	35.0
TLC59116FIRHBR	VQFN	RHB	32	3000	356.0	356.0	35.0

PW (R-PDSO-G28)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 B. This drawing is subject to change without notice.

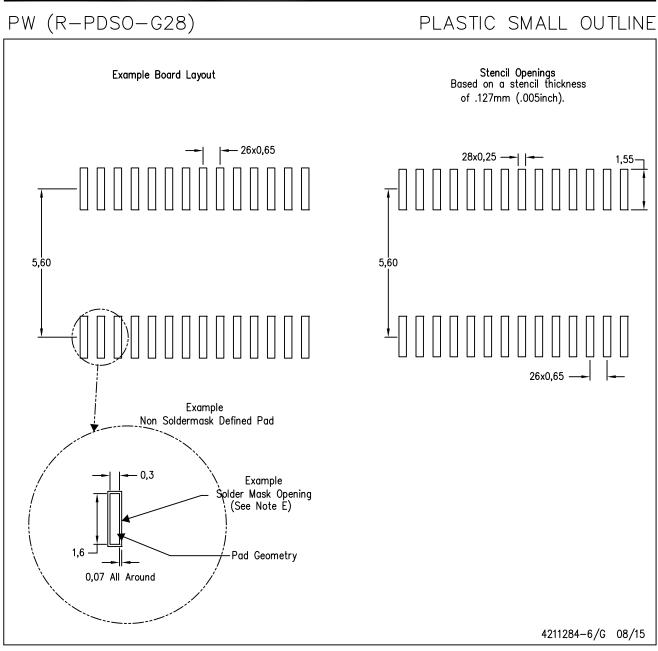
Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



LAND PATTERN DATA



NOTES: All linear dimensions are in millimeters. Α.

- B. This drawing is subject to change without notice.
 C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



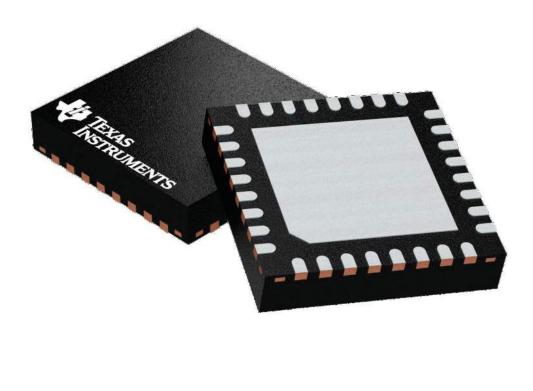
RHB 32

5 x 5, 0.5 mm pitch

GENERIC PACKAGE VIEW

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



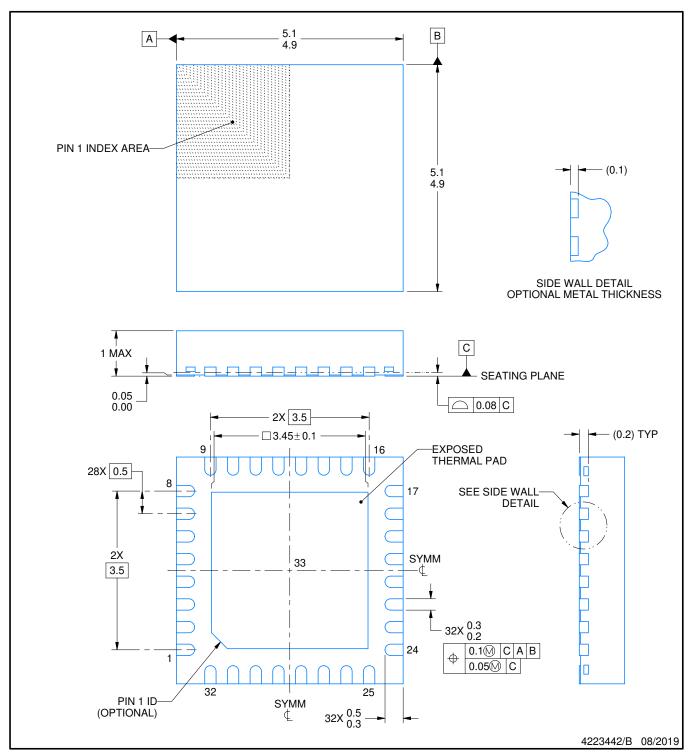
RHB0032E



PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

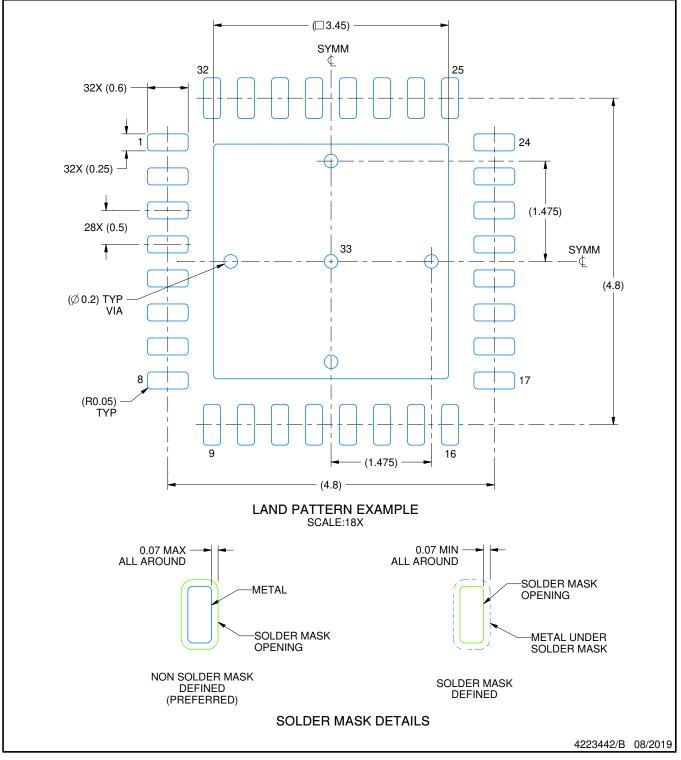


RHB0032E

EXAMPLE BOARD LAYOUT

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

 Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

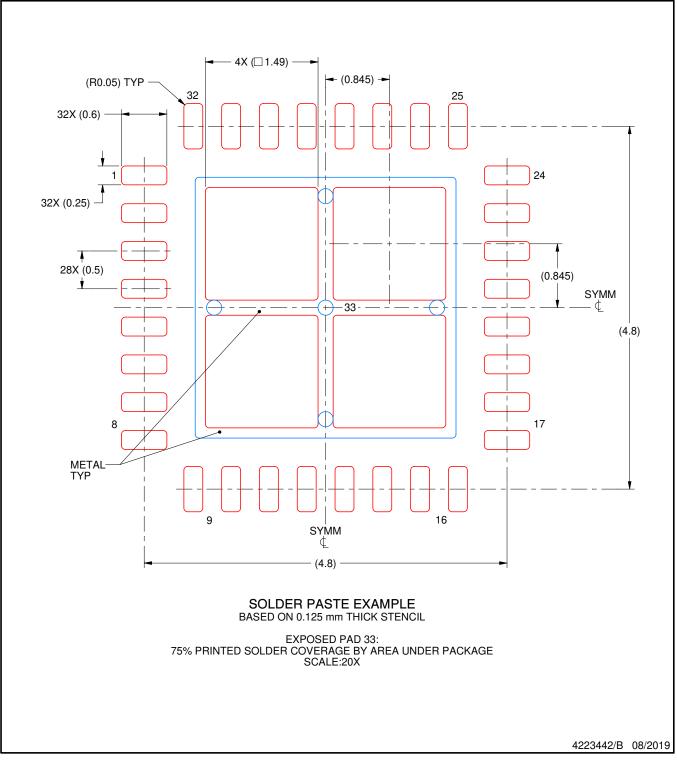


RHB0032E

EXAMPLE STENCIL DESIGN

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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